

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: H. MATSUURA, et al.  
Serial No.: 10/519,713  
Filed: DECEMBER 30, 2004  
Title: ADHESIVE FILM FOR SEMICONDUCTOR USE, METAL SHEET LAMINATED WITH ADHESIVE FILM, WIRING CIRCUIT LAMINATED WITH ADHESIVE FILM, AND SEMICONDUCTOR  
Group AU: 2823  
Examiner: Julio J. Maldonado  
Confirm. No: 7508

**INFORMATION DISCLOSURE STATEMENT  
UNDER 37 CFR 1.97 AND 1.98****Mail Stop: AMEND – NO FEE**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

October 5, 2007

Sir:

Pursuant to Applicants' duty of disclosure, enclosed please find a copy of an Official Action issued on July 6, 2007, in a counterpart Chinese application, together with an English translation thereof. Also enclosed is a Form PTO/SB/08A, listing the enclosed document.

The enclosed Official Action cites two references, No. WO 01/35460 and U.S. Patent No. 5,273,938. These documents cited in the enclosed Official Action have previously been cited in the above-identified application, No. WO 01/35460 having been cited and submitted in the Information Disclosure Statement filed December 30, 2004, and U.S. Patent No. 5,273,938 having been cited by the Examiner in the office Action mailed November 16, 2006, in the above-identified application.

This Information Disclosure Statement is being submitted subsequent to a first Office Action on the merits in the above-identified application, in an application which is not under a Final rejection and in which a Notice of Allowance has not been

issued, and in which no other action closing prosecution on the merits has been issued. For satisfying requirements of 37 CFR 1.97(c), the following Statement is made under 37 CFR 1.97(e):

Each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

While the enclosed Official Action in the counterpart Chinese application is not in English, it is respectfully submitted that requirements of 37 CFR 1.98(a)(3) are satisfied by the enclosed English translation thereof.

In view of the foregoing, it is respectfully submitted that all applicable requirements of 37 CFR 1.97 and 1.98 have been satisfied, in connection with the document listed on the enclosed Form. Accordingly, consideration of the listed document, upon further examination of the above-identified application, is respectfully requested.

Please charge any shortage of fees due in connection with the filing of this paper to the Deposit Account of Antonelli, Terry, Stout & Kraus, LLP, Deposit Account No. 01-2135 (case No. 1204.44601X00), and credit any excess fees to such Deposit Account.

Respectfully submitted,

**ANTONELLI, TERRY, STOUT & KRAUS, LLP**

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